

#### 19-OUTPUT DB1900Z LOW-POWER DERIVATIVE

9ZXL1930

## **Description**

The 9ZXL1930 is a low power version of the Intel DB1900Z Differential Buffer utilizing Low-Power HCSL (LP-HCSL) outputs to reduce power consumption more than 50% from the original IDT9ZX21901. It is suitable for PCI-Express Gen1/2/3 or QPI/UPI applications, and uses a fixed external feedback to maintain low drift for demanding QPI/UPI applications.

## **Recommended Application**

Buffer for Romley, Grantley and Purley Servers

# **Key Specifications**

- Cycle-to-cycle jitter: < 50ps</li>
- Output-to-output skew: <85ps
- Input-to-output delay: Fixed at 0 ps
- Input-to-output delay variation: <50ps</li>
- Phase jitter: PCIe Gen3 < 1ps rms
- Phase jitter: QPI/UPI 9.6GB/s < 0.2ps rms

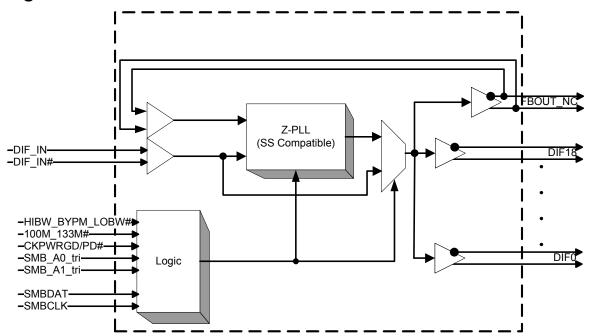
### Features/Benefits

- · Fixed feedback path; Ops input-to-output delay
- 9 Selectable SMBus addresses; Multiple devices can share same SMBus segment
- Separate VDDIO for outputs; allows maximum power savings
- PLL or bypass mode; PLL can dejitter incoming clock
- Selectable PLL BW; minimizes jitter peaking in downstream PLL's
- Spread spectrum compatible; tracks spreading input clock for EMI reduction
- SMBus Interface; unused outputs can be disabled
- 100MHz & 133.33MHz PLL mode; Legacy QPI/UPI support
- Differential outputs are Low/Low in power down;
   Maximum power savings

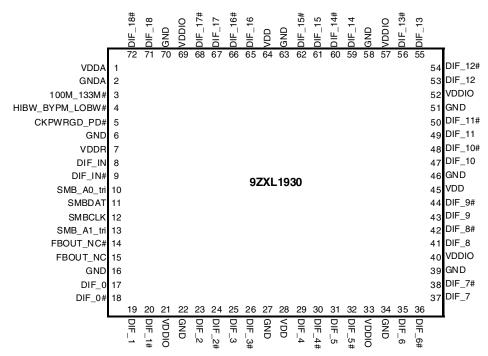
## **Output Features**

• 19 - LP-HCSL Differential Output Pairs

# **Block Diagram**



# **Pin Configuration**



## **Power Management Table**

Inputs	<b>Control Bits</b>	Control Bits Outputs			
CKPWRGD_PD#	DIF_IN/ DIF_IN#	SMBus EN bit	DIF_x/ DIF_x#	FBOUT_NC/ FB_OUT_NC#	PLL State
0	X	X	Low/Low	Low/Low	OFF
1	Running	0	Low/Low	Running	ON
'	running	1	Running	Running	ON

### **Power Connections**

	Description			
VDD	VDDIO	GND	Description	
1		2	Analog PLL	
7		6	Analog Input	
28, 45, 64	21, 33, 40, 52, 57, 69	16, 22, 27, 34, 39, 46, 51, 58, 63, 70	DIF clocks	

## Functionality at Power-up (PLL mode)

100M_133M#	DIF_IN (MHz)	DIFx (MHz)		
1	100.00	DIF_IN		
0	133.33	DIF_IN		

## **PLL Operating Mode Table**

HiBW_BypM_LoBW#	Byte0, bit (7:6)
Low ( PLL Low BW)	00
Mid (Bypass)	01
High (PLL High BW)	11

NOTE: PLL is off in Bypass mode

### **Tri-Level Input Thresholds**

Level	Voltage
Low	<0.8V
Mid	1.2 <vin<1.8v< td=""></vin<1.8v<>
High	Vin > 2.2V

# **Pin Descriptions**

PIN#	PIN NAME	PIN TYPE	DESCRIPTION
1	VDDA	PWR	3.3V power for the PLL core.
2	GNDA	PWR	Ground pin for the PLL core.
3	10014 12214#	IN	3.3V Input to select operating frequency
3	100M_133M#	IIN	See Functionality Table for Definition
	LUDW DVDM LODWU	INI	Trilevel input to select High BW, Bypass or Low BW mode.
4	HIBW_BYPM_LOBW#	IN	See PLL Operating Mode Table for Details.
5	CKPWRGD_PD#	IN	Notifies device to sample latched inputs and start up on first high assertion, or exit Power Down Mode on subsequent assertions. Low enters Power Down Mode.
6	GND	PWR	Ground pin.
7	VDDR	PWR	3.3V power for differential input clock (receiver). This VDD should be treated as an
′	VDDN	FWN	analog power rail and filtered appropriately.
8	DIF_IN	IN	0.7 V Differential TRUE input
9	DIF_IN#	IN	0.7 V Differential Complementary Input
10	SMB_A0_tri	IN	SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A1
10	SIVID_AO_III	IIN	to decode 1 of 9 SMBus Addresses.
11	SMBDAT	I/O	Data pin of SMBUS circuitry, 5V tolerant
12	SMBCLK	IN	Clock pin of SMBUS circuitry, 5V tolerant
13	SMB_A1_tri	IN	SMBus address bit. This is a tri-level input that works in conjunction with the SMB_A0
10	OMB_AT_til	111	to decode 1 of 9 SMBus Addresses.
			Complementary half of differential feedback output. This pin should NOT be connected
14	FBOUT_NC#	OUT	to anything outside the chip. It exists to provide delay path matching to get 0
			propagation delay.
			True half of differential feedback output. This pin should NOT be connected to anything
15	FBOUT_NC	OUT	outside the chip. It exists to provide delay path matching to get 0 propagation delay.
	0110		1 1 1 31 0 0 1 1 0 3
16	GND	PWR	Ground pin.
17	DIF_0	OUT	0.7V differential true clock output
18	DIF_0#	OUT	0.7V differential Complementary clock output
19	DIF_1	OUT	0.7V differential true clock output
20	DIF_1#	OUT	0.7V differential Complementary clock output
21	VDDIO	PWR	Power supply for differential outputs
22	GND	PWR	Ground pin.
23	DIF_2	OUT	0.7V differential true clock output
24	DIF_2#	OUT	0.7V differential Complementary clock output
25	DIF_3	OUT	0.7V differential true clock output
26	DIF_3#	OUT	0.7V differential Complementary clock output
27	GND	PWR	Ground pin.
28 29	VDD DIF_4	PWR OUT	Power supply, nominal 3.3V 0.7V differential true clock output
30	DIF_4 DIF 4#	OUT	0.7V differential true crock output  0.7V differential Complementary clock output
	_	OUT	·
31 32	DIF_5 DIF_5#	OUT	0.7V differential true clock output 0.7V differential Complementary clock output
33	VDDIO	PWR	Power supply for differential outputs
34	GND	PWR	Ground pin.
35	DIF_6	OUT	0.7V differential true clock output
36	DIF_6#	OUT	0.7V differential Complementary clock output
50	Dil _0#	001	o.r v amoronilar complementary clock output

# **Pin Descriptions (cont.)**

PIN#	PIN NAME	PIN TYPE	DESCRIPTION
37	DIF_7	OUT	0.7V differential true clock output
38	DIF_7#	OUT	0.7V differential Complementary clock output
39	GND	PWR	Ground pin.
40	VDDIO	PWR	Power supply for differential outputs
41	DIF_8	OUT	0.7V differential true clock output
42	DIF_8#	OUT	0.7V differential Complementary clock output
43	DIF_9	OUT	0.7V differential true clock output
44	DIF_9#	OUT	0.7V differential Complementary clock output
45	VDD	PWR	Power supply, nominal 3.3V
46	GND	PWR	Ground pin.
47	DIF_10	OUT	0.7V differential true clock output
48	DIF_10#	OUT	0.7V differential Complementary clock output
49	DIF_11	OUT	0.7V differential true clock output
50	DIF_11#	OUT	0.7V differential Complementary clock output
51	GND	PWR	Ground pin.
52	VDDIO	PWR	Power supply for differential outputs
53	DIF_12	OUT	0.7V differential true clock output
54	DIF_12#	OUT	0.7V differential Complementary clock output
55	DIF_13	OUT	0.7V differential true clock output
56	DIF_13#	OUT	0.7V differential Complementary clock output
57	VDDIO	PWR	Power supply for differential outputs
58	GND	PWR	Ground pin.
59	DIF_14	OUT	0.7V differential true clock output
60	DIF_14#	OUT	0.7V differential Complementary clock output
61	DIF_15	OUT	0.7V differential true clock output
62	DIF_15#	OUT	0.7V differential Complementary clock output
63	GND	PWR	Ground pin.
64	VDD	PWR	Power supply, nominal 3.3V
65	DIF_16	OUT	0.7V differential true clock output
66	DIF_16#	OUT	0.7V differential Complementary clock output
67	DIF_17	OUT	0.7V differential true clock output
68	DIF_17#	OUT	0.7V differential Complementary clock output
69	VDDIO	PWR	Power supply for differential outputs
70	GND	PWR	Ground pin.
71	DIF_18	OUT	0.7V differential true clock output
72	DIF_18#	OUT	0.7V differential Complementary clock output

## **Absolute Maximum Ratings**

Stresses above the ratings listed below can cause permanent damage to the 9ZXL1930. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
3.3V Core Supply Voltage	VDDA, R				4.6	V	1,2
3.3V Logic Supply Voltage	VDD				4.6	٧	1,2
I/O Supply Voltage	VDDIO				4.6	٧	1,2
Input Low Voltage	$V_{IL}$		GND-0.5			V	1
Input High Voltage	$V_{IH}$	Except for SMBus interface			V <sub>DD</sub> +0.5V	٧	1
Input High Voltage	$V_{IHSMB}$	SMBus clock and data pins			5.5V	٧	1
Storage Temperature	Ts		-65		150	°C	1
Junction Temperature	Tj				125	°C	1
Input ESD protection	ESD prot	Human Body Model	2000			V	1

<sup>&</sup>lt;sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

# **Electrical Characteristics-DIF\_IN Clock Input Parameters**

TA = T<sub>COM</sub>; Supply Voltage VDD/VDDA = 3.3 V +/-5%, VDDIO = 1.05 to 3.3V +/-5%. See Test Loads for Loading Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Input Crossover Voltage - DIF_IN	V <sub>CROSS</sub>	Cross Over Voltage	150		900	mV	1
Input Swing - DIF_IN	V <sub>SWING</sub>	Differential value	300			mV	1
Input Slew Rate - DIF_IN	dv/dt	Measured differentially	0.4		8	V/ns	1,2
Input Leakage Current	I <sub>IN</sub>	$V_{IN} = V_{DD}$ , $V_{IN} = GND$	-5		5	uA	
Input Duty Cycle	d <sub>tin</sub>	Measurement from differential wavefrom	45		55	%	1
Input Jitter - Cycle to Cycle	$J_{DIFIn}$	Differential Measurement	0		125	ps	1

<sup>&</sup>lt;sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>2</sup> Operation under these conditions is neither implied nor guaranteed.

<sup>&</sup>lt;sup>2</sup>Slew rate measured through +/-75mV window centered around differential zero

# **Electrical Characteristics-Input/Supply/Common Output Parameters**

TA = T<sub>COM</sub>; Supply Voltage VDD/VDDA = 3.3 V +/-5%, VDDIO = 1.05 to 3.3V +/-5%. See Test Loads for Loading Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Ambient Operating Temperature	T <sub>COM</sub>	Commmercial range	0		70	°C	1
Input High Voltage	V <sub>IH</sub>	Single-ended inputs, except SMBus, low threshold and tri-level inputs	2		V <sub>DD</sub> + 0.3	٧	1
Input Low Voltage	$V_{IL}$	Single-ended inputs, except SMBus, low threshold and tri-level inputs	GND - 0.3		0.8	٧	1
	I <sub>IN</sub>	Single-ended inputs, $V_{IN} = GND$ , $V_{IN} = VDD$	-5		5	uA	1
Input Current	I <sub>INP</sub>	$\label{eq:single-ended} Single-ended inputs \\ V_{IN} = 0 \text{ V}; \text{ Inputs with internal pull-up resistors} \\ V_{IN} = \text{VDD}; \text{ Inputs with internal pull-down resistors}$	-200		200	uA	1
	$F_{ibyp}$	V <sub>DD</sub> = 3.3 V, Bypass mode	33		150	MHz	2
Input Frequency	$F_{ipll}$	$V_{DD} = 3.3 \text{ V}, 100\text{MHz PLL mode}$	90	100.00	110	MHz	2
	$F_{ipll}$	V <sub>DD</sub> = 3.3 V, 133.33MHz PLL mode	120	133.33	147	7 <sub>DD</sub> + 0.3 V  0.8 V  5 uA  200 uA  150 MHz  110 MHz  147 MHz  7 nH  5 pF  2.7 pF  6 pF  1 ms  33 kHz  12 clocks  300 us  5 ns  5 ns  0.8 V	2
Pin Inductance	$L_{pin}$				7	nΗ	1
	C <sub>IN</sub>	Logic Inputs, except DIF_IN	1.5		5	pF	1
Capacitance	C <sub>INDIF_IN</sub>	DIF_IN differential clock inputs	1.5		2.7	pF	1,4
	$C_{OUT}$	Output pin capacitance			6	pF pF pF ms	1
Clk Stabilization	T <sub>STAB</sub>	From V <sub>DD</sub> Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock			1	ms	1,2
Input SS Modulation Frequency	f <sub>MODIN</sub>	Allowable Frequency (Triangular Modulation)	30		33	kHz	1
OE# Latency	t <sub>LATOE#</sub>	DIF start after OE# assertion DIF stop after OE# deassertion	4		12	clocks	1
Tdrive_PD#	t <sub>DRVPD</sub>	DIF output enable after PD# de-assertion			300	us	1,3
Tfall	t <sub>F</sub>	Fall time of control inputs			5	ns	1,2
Trise	t <sub>R</sub>	Rise time of control inputs			5	ns	1,2
SMBus Input Low Voltage	$V_{ILSMB}$				0.8	V	1
SMBus Input High Voltage	$V_{IHSMB}$		2.1		$V_{\text{DDSMB}}$		1
SMBus Output Low Voltage	$V_{OLSMB}$	@ I <sub>PULLUP</sub>				V	1
SMBus Sink Current	I <sub>PULLUP</sub>	@ V <sub>OL</sub>	4			mA	1
Nominal Bus Voltage	$V_{\text{DDSMB}}$	3V to 5V +/- 10%	2.7		5.5	V	1
SCLK/SDATA Rise Time	t <sub>RSMB</sub>	(Max VIL - 0.15) to (Min VIH + 0.15)			1000	ns	1
SCLK/SDATA Fall Time	t <sub>FSMB</sub>	(Min VIH + 0.15) to (Max VIL - 0.15)			300	ns	1
SMBus Operating Frequency	f <sub>MAXSMB</sub>	Maximum SMBus operating frequency			100	kHz	1,5

<sup>&</sup>lt;sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>2</sup>Control input must be monotonic from 20% to 80% of input swing.

<sup>&</sup>lt;sup>3</sup>Time from deassertion until outputs are >200 mV

<sup>&</sup>lt;sup>4</sup>DIF\_IN input

<sup>&</sup>lt;sup>5</sup>The differential input clock must be running for the SMBus to be active

## **Electrical Characteristics-DIF Low-Power HCSL Differential Outputs**

TA = T<sub>COM</sub>; Supply Voltage VDD/VDDA = 3.3 V +/-5%, VDDIO = 1.05 to 3.3V +/-5%. See Test Loads for Loading Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
Slew rate	Trf	Scope averaging on	1	3	4	V/ns	1, 2, 3
Slew rate matching	ΔTrf	Slew rate matching, Scope averaging on		7.6	20	%	1, 2, 4
Voltage High	VHigh	Statistical measurement on single-ended signal using oscilloscope math function. (Scope	660	757	850	mV	1
Voltage Low	VLow	averaging on)		16	150		1
Max Voltage	Vmax	Measurement on single ended signal using		857	1150	mV	1
Min Voltage	Vmin	absolute value. (Scope averaging off)	-300	-36		IIIV	1
Vswing	Vswing	Scope averaging off	300			mV	1, 2
Crossing Voltage (abs)	Vcross_abs	Scope averaging off	300	469	550	mV	1, 5
Crossing Voltage (var)	Δ-Vcross	Scope averaging off		14	140	mV	1, 6

<sup>&</sup>lt;sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.  $C_L = 2pF$  with  $R_S = 33Ω$  for Zo = 50Ω (100Ω differential trace impedance).

# **Electrical Characteristics-Current Consumption**

TA = T<sub>COM</sub>; Supply Voltage VDD/VDDA = 3.3 V +/-5%, VDDIO = 1.05 to 3.3V +/-5%. See Test Loads for Loading Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
	I <sub>DDVDD</sub>	All outputs @100MHz, $C_L = 2pF$ ; $Zo=85 \Omega$		23	35	mA	1
Operating Supply Current	I <sub>DDVDDA/R</sub>	All outputs @100MHz, $C_L = 2pF$ ; $Zo=85 \Omega$		12	20	mA	1
	I <sub>DDVDDIO</sub>	All outputs @100MHz, $C_L = 2pF$ ; $Zo=85 \Omega$	$Z_0=85 \Omega$ 23 35 mA ; $Z_0=85 \Omega$ 12 20 mA ; $Z_0=85 \Omega$ 151 175 mA $Z_0=85 \Omega$ 2.9 6 mA $Z_0=85 \Omega$ 4.4 6 mA	1			
	I <sub>DDVDDPD</sub>	All differential pairs low/low		2.9	6	mA	1,2
Powerdown Current	I <sub>DDVDDA/RPD</sub>	All differential pairs low/low		4.4	6	mA	1,2
	I <sub>DDVDDIOPD</sub>	All differential pairs low/low		0.05	1.5	mA	1,2

<sup>&</sup>lt;sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>2</sup> Measured from differential waveform

<sup>&</sup>lt;sup>3</sup> Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

<sup>&</sup>lt;sup>4</sup> Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

<sup>&</sup>lt;sup>5</sup> Vcross is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

<sup>&</sup>lt;sup>6</sup> The total variation of all Vcross measurements in any particular system. Note that this is a subset of Vcross\_min/max (Vcross absolute) allowed. The intent is to limit Vcross induced modulation by setting  $\Delta$ -Vcross to be smaller than Vcross absolute.

<sup>&</sup>lt;sup>2</sup> With input clock running. Stopping the input clock will result in lower numbers.

## **Electrical Characteristics-Skew and Differential Jitter Parameters**

TA = T<sub>COM</sub>; Supply Voltage VDD/VDDA = 3.3 V +/-5%, VDDIO = 1.05 to 3.3V +/-5%. See Test Loads for Loading Conditions

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	NOTES
CLK_IN, DIF[x:0]	t <sub>SPO_PLL</sub>	Input-to-Output Skew in PLL mode nominal value @ 25°C, 3.3V	-100	-44	100	ps	1,2,4,5,8
CLK_IN, DIF[x:0]	t <sub>PD_BYP</sub>	Input-to-Output Skew in Bypass mode nominal value @ 25°C, 3.3V	2.5	3.6	4.5	ns	1,2,3,5,8
CLK_IN, DIF[x:0]	t <sub>DSPO_PLL</sub>	Input-to-Output Skew Varation in PLL mode across voltage and temperature	-50	-2	50	ps	1,2,3,5,8
CLK_IN, DIF[x:0]	t <sub>DSPO_BYP</sub>	Input-to-Output Skew Varation in Bypass mode across voltage and temperature	-250		250	ps	1,2,3,5,8
CLK_IN, DIF[x:0]	t <sub>DTE</sub>	Random Differential Tracking error beween two 9ZX devices in Hi BW Mode		3	5	ps (rms)	1,2,3,5,8
CLK_IN, DIF[x:0]	t <sub>DSSTE</sub>	Random Differential Spread Spectrum Tracking error beween two 9ZX devices in Hi BW Mode		15	75	ps	1,2,3,5,8
DIF{x:0]	t <sub>SKEW_ALL</sub>	Output-to-Output Skew across all outputs (Common to Bypass and PLL mode)		76	85	ps	1,2,3,8
PLL Jitter Peaking	<b>j</b> peak-hibw	LOBW#_BYPASS_HIBW = 1	0	1.75	2.5	dB	7,8
PLL Jitter Peaking	jpeak-lobw	LOBW#_BYPASS_HIBW = 0	0	0.75	2	dB	7,8
PLL Bandwidth	pll <sub>HIBW</sub>	LOBW#_BYPASS_HIBW = 1	2	3.33	4	MHz	8,9
PLL Bandwidth	pll <sub>LOBW</sub>	LOBW#_BYPASS_HIBW = 0	0.7	1.18	1.4	MHz	8,9
Duty Cycle	t <sub>DC</sub>	Measured differentially, PLL Mode	45	50.4	55	%	1
Duty Cycle Distortion	t <sub>DCD</sub>	Measured differentially, Bypass Mode @100MHz	-2	0	2	%	1,10
Jitter, Cycle to cycle	t <sub>icyc-cyc</sub>	PLL mode		24	50	ps	1,11
2, 2 <b>,</b> 3.0 to 6, 6.0	-jcyc-cyc	Additive Jitter in Bypass Mode		0	50	ps	1,11

### Notes for preceding table:

<sup>1</sup> Measured into fixed 2 pF load cap. Input to output skew is measured at the first output edge following the corresponding input.

<sup>&</sup>lt;sup>2</sup> Measured from differential cross-point to differential cross-point. This parameter can be tuned with external feedback path, if present.

<sup>&</sup>lt;sup>3</sup> All Bypass Mode Input-to-Output specs refer to the timing between an input edge and the specific output edge created by it.

<sup>&</sup>lt;sup>4</sup> This parameter is deterministic for a given device

<sup>&</sup>lt;sup>5</sup> Measured with scope averaging on to find mean value.

<sup>&</sup>lt;sup>6.</sup> t is the period of the input clock

<sup>&</sup>lt;sup>7</sup> Measured as maximum pass band gain. At frequencies within the loop BW, highest point of magnification is called PLL jitter peaking.

<sup>&</sup>lt;sup>8.</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>9</sup> Measured at 3 db down or half power point.

<sup>&</sup>lt;sup>10</sup> Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode.

<sup>&</sup>lt;sup>11</sup> Measured from differential waveform

## **Electrical Characteristics-Phase Jitter Parameters**

 $TA = T_{COM}; \ Supply \ Voltage \ VDD/VDDA = 3.3 \ V + /-5\%, \ VDDIO = 1.05 \ to \ 3.3 V + /-5\%. \ See \ Test \ Loads \ for \ Loading \ Conditions$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	Notes
	t <sub>iphPCleG1</sub>	PCIe Gen 1		30	86	ps (p-p)	1,2,3
	t	PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz		1.0	3	ps (rms)	1,2
	t <sub>jphPCleG2</sub>	PCIe Gen 2 High Band 1.5MHz < f < Nyquist (50MHz)		1.7	3.1	ps (rms)	1,2
Phase Jitter, PLL Mode	t <sub>jphPCleG3</sub>	PCIe Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz)		0.38	1	ps (rms)	1,2,4
		QPI & SMI (100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI)		0.18	0.5	ps (rms)	1,2,3 1,2 1,2 1,2,4 1,5 1,5
	t <sub>jphQPI_SMI</sub>	QPI & SMI (100MHz, 8.0Gb/s, 12UI)		0.13	0.3	ps (rms)	
		QPI & SMI (100MHz, 9.6Gb/s, 12UI)		0.10	0.2	ps (rms)	
	t <sub>iphPCleG1</sub>	PCIe Gen 1		0	10	ps (p-p)	1,2,3
		PCIe Gen 2 Lo Band 10kHz < f < 1.5MHz		0.0	0.3	ps (rms)	1,2,6
	t <sub>jphPCleG2</sub>	PCIe Gen 2 High Band 1.5MHz < f < Nyquist (50MHz)		0.0	0.7	ps (rms)	1,2,6
Additive Phase Jitter, Bypass mode	t <sub>jphPCleG3</sub>	PCIe Gen 3 (PLL BW of 2-4MHz, CDR = 10MHz)		0.0	0.3	ps (rms)	1,2,4,6
Dypado modo		QPI & SMI (100MHz or 133MHz, 4.8Gb/s, 6.4Gb/s 12UI)		0.12	0.3	ps (rms)	1,5,6
	t <sub>jphQPI_SMI</sub>	QPI & SMI (100MHz, 8.0Gb/s, 12UI)		0.00	0.1	ps (rms)	1,5,6
		QPI & SMI (100MHz, 9.6Gb/s, 12UI)		0.00	0.1	ps (rms)	1,5,6

<sup>&</sup>lt;sup>1</sup> Applies to all outputs.

<sup>&</sup>lt;sup>2</sup> See http://www.pcisig.com for complete specs

<sup>&</sup>lt;sup>3</sup> Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.

<sup>&</sup>lt;sup>4</sup> Subject to final ratification by PCI SIG.

<sup>&</sup>lt;sup>5</sup> Calculated from Intel-supplied Clock Jitter Tool v 1.6.3

 $<sup>^6</sup>$  For RMS figures, additive jitter is calculated by solving the following equation: (Additive jitter) $^2$  = (total jitter) $^2$  - (input jitter) $^2$ 

# Clock Periods-Differential Outputs with Spread Spectrum Disabled

					<b>Measurement</b>	Window				
	Center	1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
SSC OFF	Freq. MHz	-c2c jitter AbsPer Min	-SSC Short-Term Average Min	- ppm Long-Term Average Min	0 ppm Period Nominal	+ ppm Long-Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max	Units	Notes
DIF	100.00	9.94900		9.99900	10.00000	10.00100		10.05100	ns	1,2,3
511	133.33	7.44925		7.49925	7.50000	7.50075		7.55075	ns	1,2,4

# Clock Periods-Differential Outputs with Spread Spectrum Enabled

			Measurement Window							
	Center	1 Clock	1us	0.1s	0.1s	0.1s	1us	1 Clock		
SSC ON	Freq. MHz	-c2c jitter AbsPer Min	-SSC Short-Term Average Min	- ppm Long-Term Average Min	0 ppm Period Nominal	+ ppm Long-Term Average Max	+SSC Short-Term Average Max	+c2c jitter AbsPer Max	Units	Notes
DIF	99.75	9.94906	9.99906	10.02406	10.02506	10.02607	10.05107	10.10107	ns	1,2,3
Ы	133.00	7.44930	7.49930	7.51805	7.51880	7.51955	7.53830	7.58830	ns	1,2,4

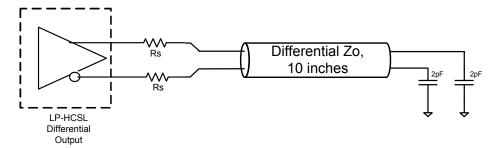
#### Notes:

### **Test Loads**

**Differential Output Terminations** 

DIF Zo (Ω)	Rs $(\Omega)$
100	33
85	27

### 9ZXL Differential Test Loads



<sup>&</sup>lt;sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>&</sup>lt;sup>2</sup> All Long Term Accuracy specifications are guaranteed with the assumption that the input clock complies with CK420BQ/CK410B+ accuracy requirements (+/-100ppm). The 9ZXL1930 itself does not contribute to ppm error.

<sup>&</sup>lt;sup>3</sup> Driven by SRC output of main clock, 100 MHz PLL Mode or Bypass mode

<sup>&</sup>lt;sup>4</sup> Driven by CPU output of main clock, 133 MHz PLL Mode or Bypass mode

## **General SMBus Serial Interface Information**

### **How to Write**

- · Controller (host) sends a start bit
- · Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) sends the byte count = X
- IDT clock will acknowledge
- Controller (host) starts sending Byte N through Byte N+X-1
- IDT clock will acknowledge each byte one at a time
- Controller (host) sends a Stop bit

	Index Block Write Operation									
Controll	er (Host)		IDT (Slave/Receiver)							
Т	starT bit									
Slave A	Address									
WR	WRite									
			ACK							
Beginning Byte = N										
			ACK							
Data Byte	Count = X									
			ACK							
Beginnin	g Byte N									
			ACK							
0		×								
0		X Byte	0							
0		e	0							
			0							
Byte N	Byte N + X - 1									
			ACK							
Р	stoP bit									

### **How to Read**

- Controller (host) will send a start bit
- Controller (host) sends the write address
- IDT clock will acknowledge
- Controller (host) sends the beginning byte location = N
- IDT clock will acknowledge
- Controller (host) will send a separate start bit
- Controller (host) sends the read address
- IDT clock will acknowledge
- IDT clock will send the data byte count = X
- IDT clock sends Byte N+X-1
- IDT clock sends Byte 0 through Byte X (if X<sub>(H)</sub> was written to Byte 8)
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- · Controller (host) will send a stop bit

	Index Block Read Operation							
Cor	ntroller (Host)		IDT (Slave/Receiver)					
Т	starT bit							
SI	ave Address							
WR	WRite							
			ACK					
Begi	Beginning Byte = N							
			ACK					
RT	RT Repeat starT							
SI	ave Address							
RD	RD ReaD							
			ACK					
			Data Byte Count=X					
	ACK							
			Beginning Byte N					
	ACK							
		<u>e</u>	0					
	0	X Byte	0					
	0	×	0					
	0							
			Byte N + X - 1					
N	Not acknowledge							
Р	stoP bit							

9ZXL1930 SMBus Addressing

SMB_A(1:0)_tri	SMBus Address (Rd/Wrt bit = 0)
00	D8
OM	DA
01	DE
MO	C2
MM	C4
M1	C6
10	CA
1M	CC
11	CE

SMBusTable: PLL Mode, and Frequency Select Register

Byte		Name	Control Function	Туре	0	1	Default
Bit 7	4	PLL Mode 1	PLL Operating Mode Rd back 1	R	See PLL Op	See PLL Operating Mode	
Bit 6	4	PLL Mode 0	PLL Operating Mode Rd back 0	R	Readback Table		Latch
Bit 5	72/71	DIF_18_En	Output Control overrides OE# pin	RW	Low/Low	Enable	1
Bit 4	68/67	DIF_17_En	Output Control overrides OE# pin	RW	Low/Low	Enable	1
Bit 3	66/65	DIF_16_En	Output Control overrides OE# pin	RW	Low/Low	Enable	1
Bit 2		Reserved					0
Bit 1		Reserved					0
Bit 0	3	100M_133M#	Frequency Select Readback	R	133MHz	100MHz	Latch

SMB usTable: Output Control Register

OMB distribute: Output Control rregister								
Byte :	1 Pin #	Name	Control Function	Туре	0	1	Default	
Bit 7	38/37	DIF_7_En	Output Control overrides OE# pin	RW			1	
Bit 6	35/36	DIF_6_En	Output Control overrides OE# pin	RW			1	
Bit 5	31/32	DIF_5_En	Output Control overrides OE# pin	RW		Enable	1	
Bit 4	29/30	DIF_4_En	Output Control overrides OE# pin	RW	Low/Low		1	
Bit 3	25/26	DIF_3_En	Output Control overrides OE# pin	RW	LOW/LOW		1	
Bit 2	23/24	DIF_2_En	Output Control overrides OE# pin	RW			1	
Bit 1	19/20	DIF_1_En	Output Control overrides OE# pin	RW			1	
Bit 0	17/18	DIF_0_En	Output Control overrides OE# pin	RW			1	

SMB usTable: Output Control Register

Byte 2	2 Pin #	Name	Control Function	Type	0	1	Default
Bit 7	62/61	DIF_15_En	Output Control overrides OE# pin	RW			1
Bit 6	60/59	DIF_14_En	Output Control overrides OE# pin	RW			1
Bit 5	56/55	DIF_13_En	Output Control overrides OE# pin	RW		Enable	1
Bit 4	54/53	DIF_12_En	Output Control overrides OE# pin	RW	Low/Low		1
Bit 3	50/49	DIF_11_En	Output Control overrides OE# pin	RW	LOW/LOW		1
Bit 2	48/47	DIF_10_En	Output Control overrides OE# pin	RW			1
Bit 1	44/43	DIF_9_En	Output Control overrides OE# pin	RW			1
Bit 0	42/41	DIF_8_En	Output Control overrides OE# pin	RW			1

SMBusTable: Reserved Register

Byte 3	Pin #	Name	Control Function	Type	0	1	Default	
Bit 7			Reserved					
Bit 6			Reserved					
Bit 5			Reserved					
Bit 4			Reserved					
Bit 3			Reserved					
Bit 2			Reserved					
Bit 1		Reserved						
Bit 0			Reserved				0	

SMBusTable: Reserved Register

Byte 4	Pin #	Name	Control Function	Type	0	1	Default	
Bit 7		Reserved				0		
Bit 6			Reserved					
Bit 5			Reserved					
Bit 4		Reserved					0	
Bit 3		Reserved					0	
Bit 2		Reserved					0	
Bit 1		Reserved				0		
Bit 0			Reserved					

SMBusTable: Vendor & Revision ID Register

Byte	5 Pin #	Name	Control Function	Type	0	1	Default	
Bit 7	-	RID3		R	A rev = 0000		X	
Bit 6	-	RID2	REVISION ID  REVISION ID  REVISION ID					Х
Bit 5	-	RID1	NEVISION ID	R	etc.		X	
Bit 4	-	RID0		R			Х	
Bit 3	-	VID3		R	-	-	0	
Bit 2	-	VID2	VENDOD ID	R	-	-	0	
Bit 1	-	VID1	VENDOR ID	R	-	-	0	
Bit 0	-	VID0		R	-	-	1	

SMBusTable: DEVICE ID

Byte 6	Pin #	Name	Control Function	Туре	0	1	Default
Bit 7	-	Device ID 7 (MSB)		R			1
Bit 6	-	Device ID 6		R			Х
Bit 5	-		Device ID 5	R			Χ
Bit 4	-		Device ID 4		1930 is 193 Decimal or C1 Hex		Х
Bit 3	-		Device ID 3				Х
Bit 2	-		Device ID 2	R			0
Bit 1	-		Device ID 1	R			0
Bit 0	-		Device ID 0	R			1

SMBusTable: Byte Count Register

Byte 7	Pin #	Name	Control Function	Type	0	1	Default
Bit 7	·	Reserved				0	
Bit 6			Reserved				0
Bit 5			Reserved				0
Bit 4	-	BC4		RW			0
Bit 3	-	BC3	Writing to this register configures how	RW	Default value	is 8 hex, so 9	1
Bit 2	-	BC2	many bytes will be read back.	RW	bytes (0 to 8) will be read back		0
Bit 1	-	BC1	many bytes will be read back.	RW	by default.		0
Bit 0	-	BC0		RW			0

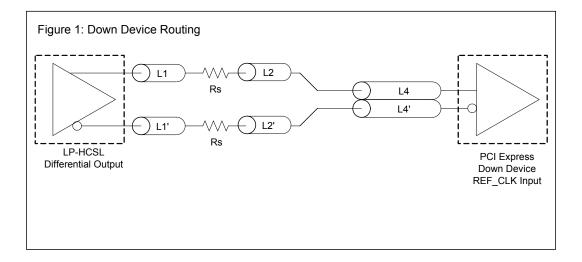
SMBusTable: Reserved Register

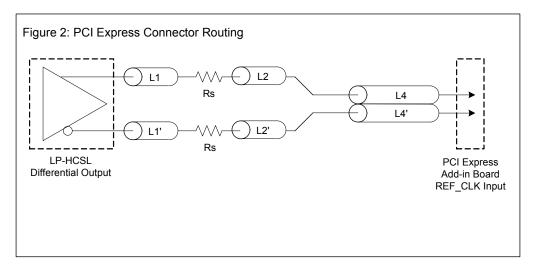
Byte 8	Pin #	Name	Control Function	Type	0	1	Default
Bit 7		Reserved				0	
Bit 6		Reserved				0	
Bit 5			Reserved				
Bit 4		Reserved					0
Bit 3		Reserved					0
Bit 2		Reserved				0	
Bit 1		Reserved				0	
Bit 0			Reserved				0

DIF Reference Clock						
Common Recommendations for Differential Routing	Dimension or Value	Unit	Figure			
L1 length, route as non-coupled 50ohm trace	0.5 max	inch	1			
L2 length, route as non-coupled 50ohm trace	0.2 max	inch	1			
L3 length, route as non-coupled 50ohm trace	0.2 max	inch	1			
Rs (100 ohm differential traces)	33	ohm	1			
Rs (85 ohm differential traces)	27	ohm	1			

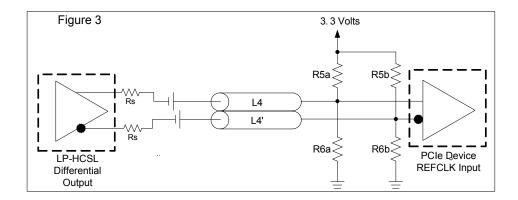
Down Device Differential Routing			
L4 length, route as coupled microstrip 100ohm differential trace	2 min to 16 max	inch	1
L4 length, route as coupled stripline 100ohm differential trace	1.8 min to 14.4 max	inch	1

Differential Routing to PCI Express Connector			
L4 length, route as coupled microstrip 100ohm differential trace	0.25 to 14 max	inch	2
L4 length, route as coupled stripline 100ohm differential trace	0.225 min to 12.6 max	inch	2





Cable Connected AC Coupled Application (Figure 3)					
Component	Value	Note			
R5a, R5b	8.2K 5%				
R6a, R6b	1K 5%				
Cc	0.1 µF				
Vcm	0.350 volts				



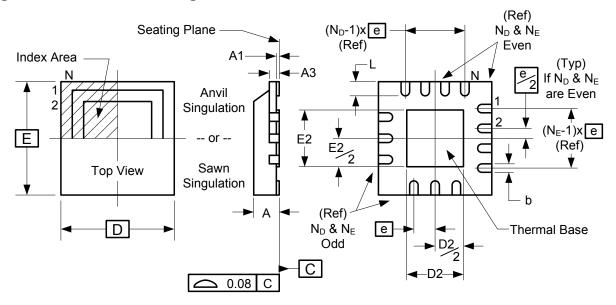
# **Marking Diagram**



#### Notes:

- 1. 'LOT' is the lot number.
- 2. YYWW is the last two digits of the year and week that the part was assembled.
- 3. "LF" denotes RoHS compliant package.
- 4. 'COO" deontes country of origin.

## Package Outline and Package Dimensions (72-pin MLF)



	Millimeters		
Symbol	Min	Max	
Α	0.8	1.0	
A1	0	0.05	
A3	0.25 Re	ference	
b	0.18	0.3	
е	0.50 BASIC		
D x E BASIC	10.00	< 10.00	
D2 MIN./MAX.	5.75	6.15	
E2 MIN./MAX.	5.75	6.15	
L MIN./MAX.	0.3	0.5	
$N_D$	18		
N <sub>E</sub>	1	8	

# **Ordering Information**

Part / Order Number	Marking	<b>Shipping Packaging</b>	Package	Temperature
9ZXL1930BKLF	see page 15	Tray	72-pin MLF	0 to +70° C
9ZXL1930BKLFT		Tape and Reel	72-pin MLF	0 to +70° C

<sup>&</sup>quot;LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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<sup>&</sup>quot;B" is the device revision designator (will not correlate with the datasheet revision).

# **Revision History**

Rev.	Issuer	Issue Date	Description	Page #
А	RDW	12/8/2011	<ol> <li>Updated key specifications table Output to Output skew to 85ps</li> <li>Updated Electrical Tables with typical specs</li> <li>Updated Byte 5 for REV ID</li> <li>Moved to Final</li> </ol>	1,6-9,13
В	RDW	3/12/2012	<ul><li>1. Various typo fixes, changed output references to LP-HCSL.</li><li>2. Added Test Loads figure and table.</li></ul>	1,9,10,14
С	RDW	6/25/2214	1. Slightly increased MAX power down currents. 2. Clarified block diagram to indicate that there are multiple outputs. 3. Changed title of output characterisitics table to "Electrical Characteristics - DIF Low-Power HCSL Differential Outputs" to follow new standard. 4. Reformatted Figures 2 and 3 for consistency/clarity	1,7,14,15
D	RDW	11/20/2015	Updated QPI references to QPI/UPI     Updated DIF_IN table to match PCI SIG specification, no silicon change	1,5

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